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Author Correction: Physical and chemical descriptors for predicting interfacial thermal resistance

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Following publication of this Data Descriptor, it was found that references in the “Reference (id-R)” column of Table 1 that were intended to correspond to references in the ITR dataset.xlsx file of the accompanying dataset were incorrectly displayed as bibliographic references. Table 1 has been updated to make this distinction clear in both the HTML and PDF versions.



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